



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

IPW

NOV 02 2005  
Applicant:

Leonard Forbes et al.

Title:

STRAINED SEMICONDUCTOR BY FULL WAFER BONDING

Docket No.: 1303.109US1

Serial No.: 10/623,788

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Due Date: October 30, 2005

Examiner: Pamela E. Perkins

Group Art Unit: 2822

**MS Amendment**

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

- Return postcard.
- Response to Restriction Requirement (15 pgs.).
- Communication Concerning Related Applications (1 pg.).
- Supplemental Information Disclosure Statement (2 pgs.), Form 1449 (1 pg.), and copies of 2 cited documents.

If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.  
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By: PLB  
Atty: Marvin L. Beekman  
Reg. No. 38,377

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 31 day of October, 2005.

Name

KACIA LEE

Signature

Kacia Lee

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

(GENERAL)